Emitter common(dual digital transistors)

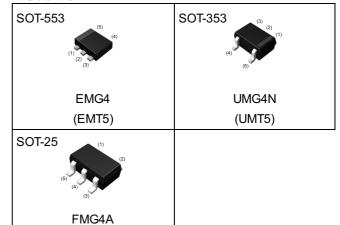
Datasheet

Parameter	DTr1 and DTr2
$V_{\sf CEO}$	50V
I _C	100mA
R ₁	10kΩ

Features

- 1)Two DTC114T chips in a EMT or UMT or SMT package.
- 2) Mounting cost and area can be cut in half.

Outline

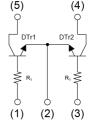


•Inner circuit

EMG4 / UMG4N

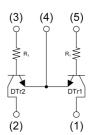
(SMT5)

- (1) DTr1 Base
- (2) DTr1 / DTr2 Emitter
- (3) DTr2 Base
- (4) DTr2 Collector
- (5) DTr1 Collector



FMG4A

- (1) DTr1 Collector
- (2) DTr2 Collector
- (3) DTr2 Base
- (4) DTr1 / DTr2 Emitter
- (5) DTr1 Base



Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMG4	SOT-553 (EMT5)	1616	T2R	180	8	8000	G4
UMG4N	SOT-353 (UMT5)	2021	TR	180	8	3000	G4
FMG4A	SOT-25 (SMT5)	2928	T148	180	8	3000	G4

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

Parameter			Symbol	Values	Unit	
Collector-base voltage			V_{CBO}	50	V	
Collector-emitter voltage			V_{CEO}	50	V	
Emitter-base voltage		V_{EBO}	5	V		
Collector current			I _C	100	mA	
	EMG4		P _D *1*2	150		
Power dissipation	UMG4N		P _D *1*2	150	mW/Total	
FMG4A			P _D *1*3	300		
Junction temperature			T _j	150	°C	
Range of storage temper	Range of storage temperature			-55 to +150	°C	

● Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

Darameter	Cymabal	Conditions	Values			Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	50	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	1	1	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 50V	-	-	500	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 4V	-	-	500	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 10mA, I _B = 1mA	-	1	300	mV
DC current gain	h _{FE}	$V_{CE} = 5V$, $I_C = 1mA$	100	250	600	-
Input resistance	R ₁	-	7	10	13	kΩ
Transition frequency	f _T *4	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz

^{*1} Each terminal mounted on a reference land.



^{*2 120}mW per element must not be exceeded.

^{*3 200}mW per element must not be exceeded.

^{*4} Characteristics of built-in transistor.

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Grounded Emitter Propagation Characteristics

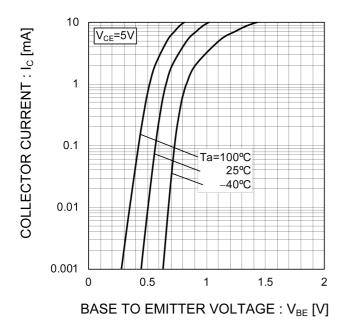


Fig.2 Grounded Emitter Output Characteristics

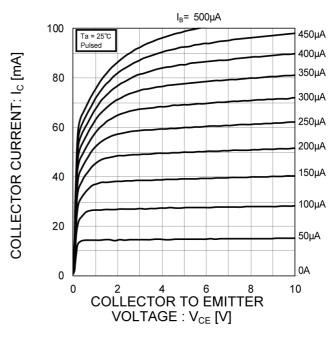


Fig.3 DC Current Gain vs. Collector Current

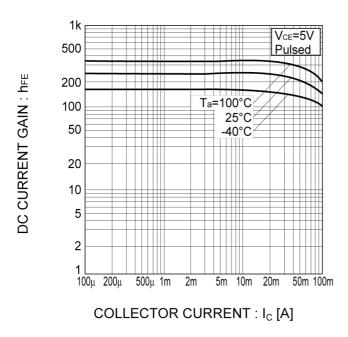
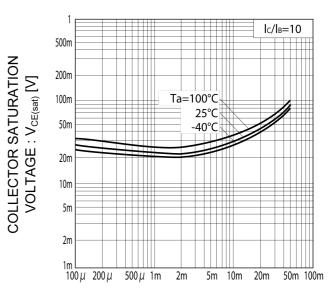
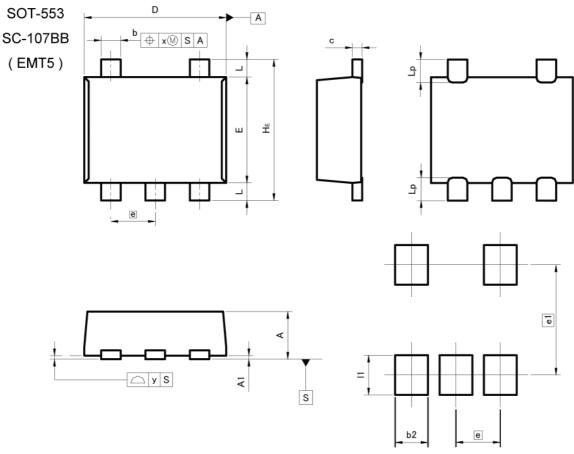


Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

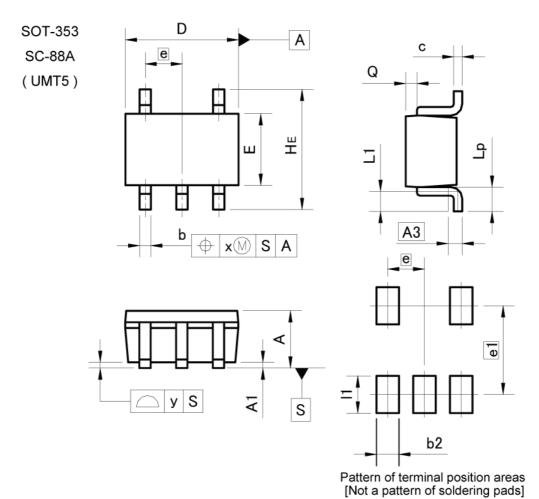
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	_	0.35	-	0.014
х	_	0.10	_	0.004
У	_	0.10	_	0.004

DIM	MILIM	ETERS	INCHES	
DIW	MIN	MAX	MIN	MAX
b2	-	0.37	ı	0.015
e1	1.25		0.0	49
11	- 0.45		-	0.018

Dimension in mm/inches



Dimensions



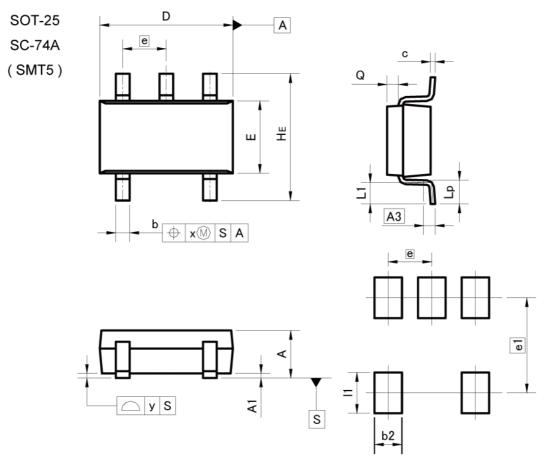
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.:	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
Е	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
Х	-	0.10	-	0.004
У		0.10	-	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	- 7	0.40	-	0.016
e1	1.55		0.0	61
- 11	-	0.65	-	0.026

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
Е	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	Ē	0.20	===	0.008
У		0.10		0.004

DIM	MILIMI	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	- 0	0.60	- 0	0.024
e1	2.10		0.0	83
11	- ->	0.90		0.035

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
CLASSIII	О. 400 Т	CLASS II b	ОГУССШ
CLASSIV	CLASSII	CLASSIII	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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